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2812

Docket No.: M4065.0468/P468
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Phillip E. Byrd, et al.

Application No.: 09/941,761

Group Art Unit: 2812

Filed: August 30, 2001

Examiner: Not Yet Assigned

For: METHOD AND STRUCTURE FOR
TEMPORARILY ISOLATING A DIE FROM
A COMMON CONDUCTOR TO
FACILITATE WAFER LEVEL TESTING

TC 2800
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SUBMISSION OF FORMAL DRAWINGS

Commissioner for Patents
Washington, DC 20231

Dear Sir:

Submitted herewith is one set (eight sheets, Figures 1-11) of formal drawings for filing in the above-identified Patent application. Kindly substitute the enclosed formal drawings for the informal drawings submitted with the originally filed application.

Dated: December 17, 2001

Respectfully submitted,

By _____

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